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Appl. No. 10/629,232
Amtd Dated Feb. 9, 2007
Reply to Office Action December 28, 2006

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|--------------|---|---|------------------|------|
| Appl. No. | : | 10/629,232 | Confirmation No. | 6566 |
| Applicant | : | Lee et al. | Inventor | |
| Filed | : | July 28, 2003 | | |
| TC/A.U. | : | 2835 | | |
| Examiner | : | Ingrid Wright | | |
| Customer No. | : | 25859 | | |
| Title | : | HEAT SINK ASSEMBLY WITH RETENTION MODULE AND CLIP | | |

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being
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Signed: 

Wei Te Chung

Honorable Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Amendment

Sir:

In response to the outstanding Final Office Action dated December 28, 2006 in connection with the above-identified application, kindly amend the above-identified application as follows and consider the accompanying remarks.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 8 of this paper.

